

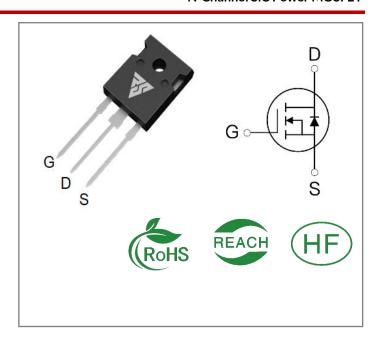
VDS	RDS(on)	ID@25℃	
1200V	80mΩ	28A	

Applications:

- Solar Inverters
- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- EV Charging
- Motor Drives

Features:

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness



Benefits:

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

Ordering Information

Part Number	Package	age Marking Packing		Qty.	
RSM120080W	TO-247-3	RSM120080W	Tube	30 PCS	

Maximum Ratings (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
VDSmax	Drain - Source Voltage	1200	V	VGS=0V,ID =100μA	
VGSmax	Gate - Source Voltage	-10/+2 5	V	Absolute maximum values	
VGSop	Gate - Source Voltage	-5/+20	V	Recommended operational values	
ID	Continuous Drain	28	Α	VGS=20V, TC =25°C	
וט	Current	20	A	VGS=20V, TC =100°C	
ID(pulse)	Pulsed Drain Current	60	Α	Pulse width tp limited by TJmax	
PD	Power Dissipation	166	W	TC =25℃, TJ =150℃	
TL	Solder Temperature	260	$^{\circ}$		
T.I. Tota	Operating Junction and	-40 to	$^{\circ}$		
TJ, Tstg	StorageTemperature	+ 150			



Electrical Characteristics (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
V(BR)D SS	Drain-Source Breakdown Voltage	120 0			V	VGS=0V,ID =100μA	
VGS(th)	Gate Threshold	2.0	2.4	4.0	V	VGS= VDS, IDS=5mA,TC =25℃	
VG3(til)	Voltage		1.73		V	VGS= VDS, IDS=5mA,TC =150 $^{\circ}$ C	
IDSS	Zero Gate Voltage Drain Current		1	100	μΑ	VDS= 1200V, VGS=0V	
IGSS	Gate-Source Leakage Current		20	200	nA	VGS=20V, VDS= 0V	
RDS(on)	Drain-Source on-state		80	98	mΩ	VGS=20V, ID =20A, TC =25℃	
KD3(0H)	Resistance		120			VGS=20V, ID =20A, TC =150°C	
Ciss	Input Capacitance		201 6			VGS=0V, VDS=1000 V,	
Coss	Output Capacitance		17.9		pF	f=1MHz, VAC=25 mV	
Crss	Reverse Transfer Capacitance		72.6			·	
EON	Turn-On Switching Energy		180		μJ	VDS =800V, VGS =-5/20V, ID = 20A,	
EOFF	Turn-Off Energy		70		μ	$RG(ext) = 5\Omega$, L= 142 μ H	
td(on)	Turn-On Delay Time		23				
tr	Rise Time		60		ns	VDS =800V, VGS =-5/20 V ID = 20A, RG(ext) = 5 Ω , RL =40 Ω	
td(off)	Turn-Off Delay Time		17		113		
tf	Fall Time		12				
RG(int)	Internal Gate Resistance		2.8		Ω	f=1 MHz, VAC=25mV	
Qgs	Gate to Source Charge		23		nC		
Qgd	Gate to Drain Charge		26		nC	VDS=800V, VGS=-5/20V ID =20A	
Qg	Total Gate Charge		85				



Reverse Diode Characteristics (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Max	Unit	Test Conditions	Note
VCD	Die de Fernand Velhage	3.5		٧	VGS=-5V, ISD = 10 A, TJ = 25°C	
VSD	Diode Forward Voltage	3.3		٧	VGS=-5V, ISD= 10 A, TJ= 150℃	
IS	Continuous Diode Forward Current		28	А	VGS=-5V,TC= 25℃	
trr	Reverse Recovery time	18		ns	NCS- EV	
Qrr	Reverse Recovery Charge	80		nC	VGS=-5V, ISD= 20 A,	
Irrm	Peak Reverse Recovery Current	8.0		Α	VR = 800V	

Thermal Characteristics (TJ= 25℃ unless otherwise specified)

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
RθJC	Thermal Resistance from Junction to Case	0.75	°C /\A/		
RθJA	Thermal Resistance From Junction to Ambient	35	°C/W		

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Typical Feature Curve

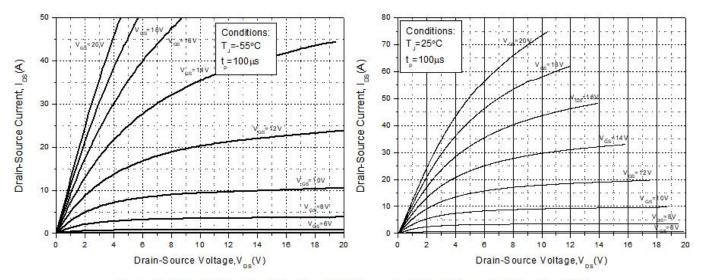


Figure 1. Output Characteristics T_J = -55 °C Figure 2. Output Characteristics T_J = 25 °C

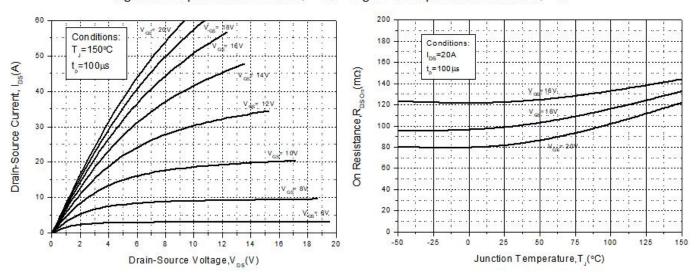


Figure 3. Output Characteristics T_J =150°C Figure 4. On-Resistance For Various Gate Voltage

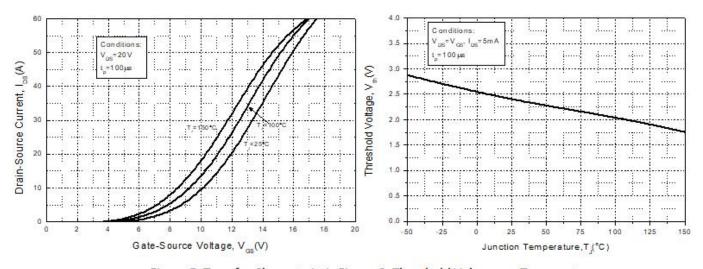


Figure 5. Transfer Characteristic Figure 6. Threshold Voltage vs. Temperature

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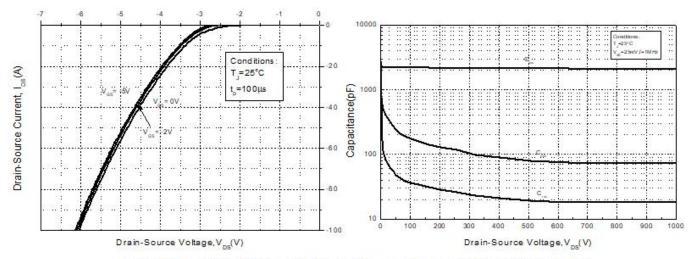


Figure 7.Body Diode CharacteristicsFigure 8. Capacitances vs. Drain-Source Voltage

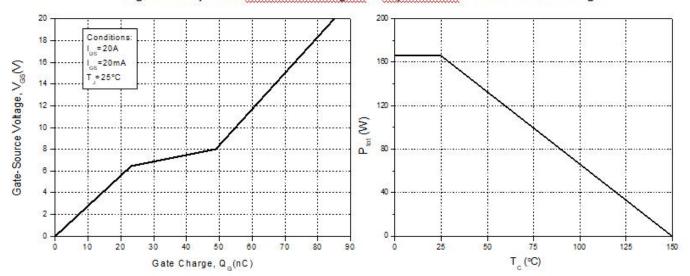


Figure 9.Gate Charge CharacteristicsFigure 10. Power Dissipation Derating

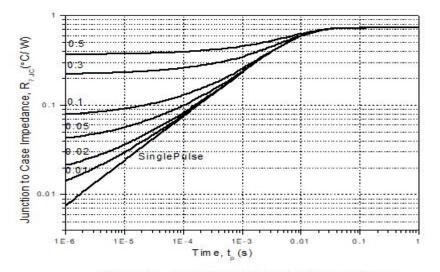


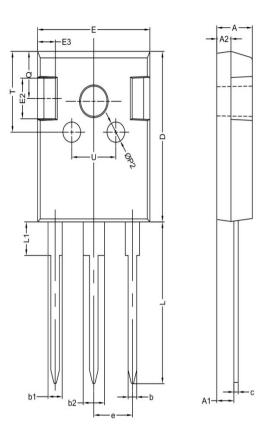
Figure 11. Transient Thermal Impendance

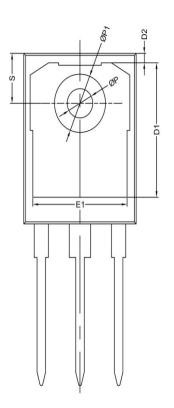
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Package outline drawing(TO-247-3 Unit: mm)





符号		机械尺寸/mn	n
	最小值	典型值	最大值
Α	4.80	5.00	5.20
A1	2.21	2.41	2.61
A2	1.90	2.00	2.10
b	1.10	1.20	1.35
b1		2.00	
b2		3.00	
С	0.55	0.60	0.75
D	20.80	21.00	21.20
D1		16.55	
D2		1.20	
E	15.60	15.80	16.0
E1		13.30	
E2		5.00	
E3		2.50	
е		5.44	
L	19.42	19.92	20.42
L1		4.13	
Р	3.50	3.60	3.70
P1	-	-	7.40
P2		2.50	
Q		5.80	
S	6.05	6.15	6.25
Т		10.00	
U		6.20	





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